



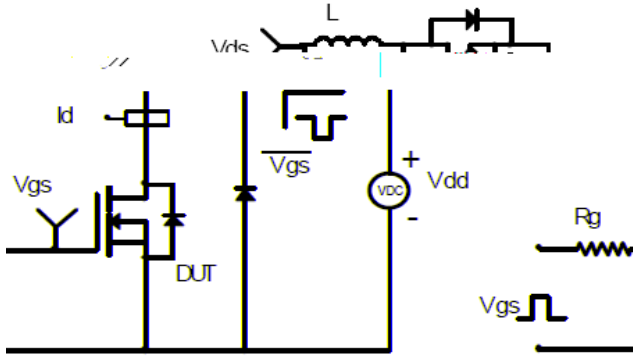


**Thermal Resistance**

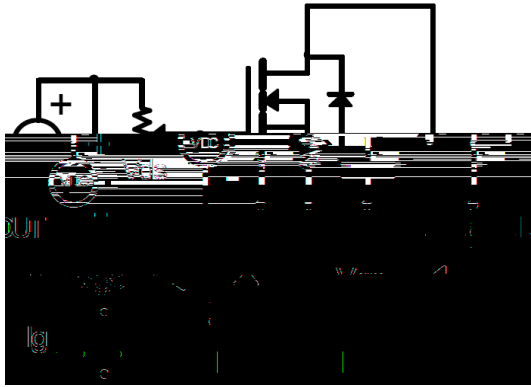
Symbol	Characterizes	Typ.	Max.	Units
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Test Circuits and Waveforms

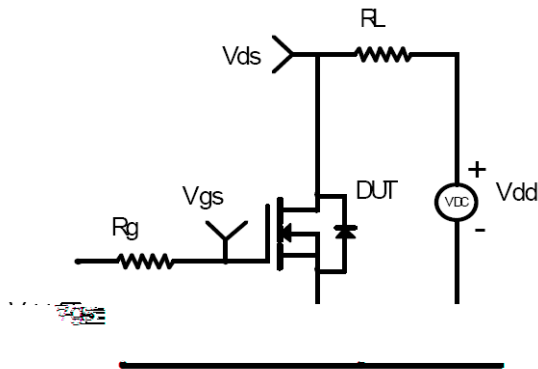
EAS Test Circuit:



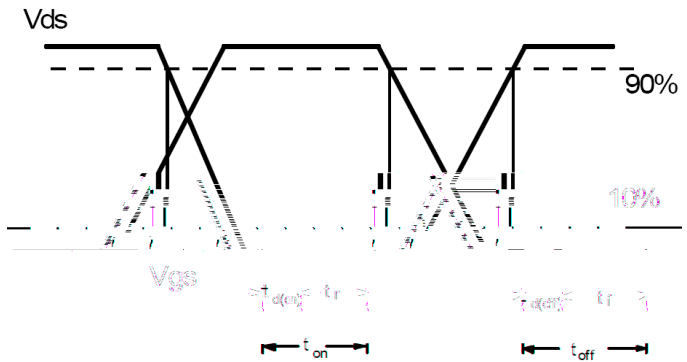
Gate Charge Test Circuit:



Switching Time Test Circuit:



Switching Waveforms:



Notes:

- 7 Calculated continuous current based on maximum allowable junction temperature.
- 8 Repetitive rating; pulse width limited by max. junction temperature.
- 9 The power dissipation PD is based on max. junction temperature, using junction-to-case thermal resistance.
- : The value of  $R_A$  is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25$

Typical Electrical and Thermal Characteristics

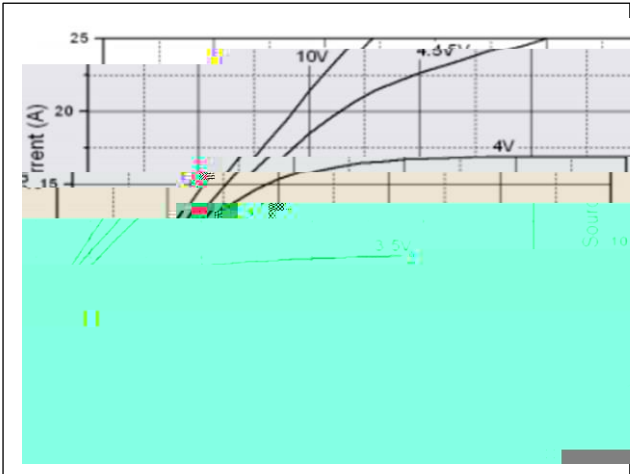


Figure1. Typical Output Characteristics



Figure2. Typical On-Resistance vs. Drain Current and Gate Voltage

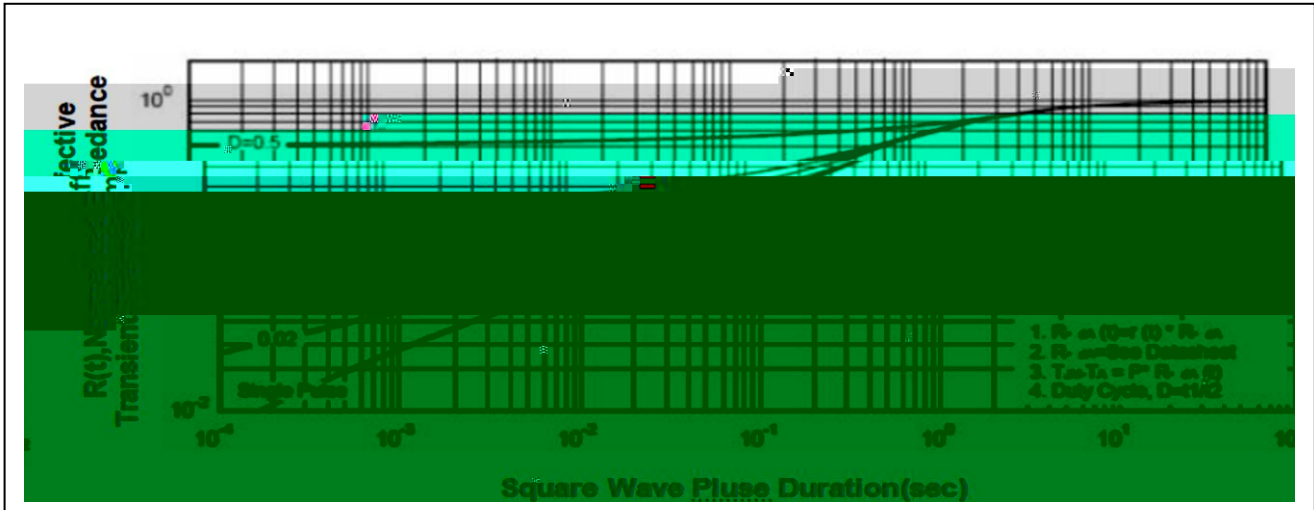
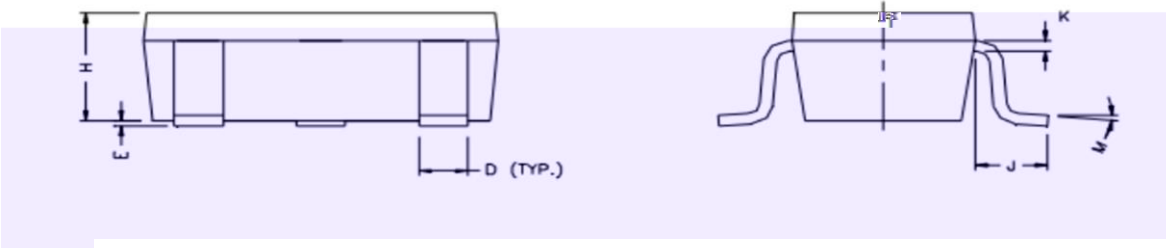
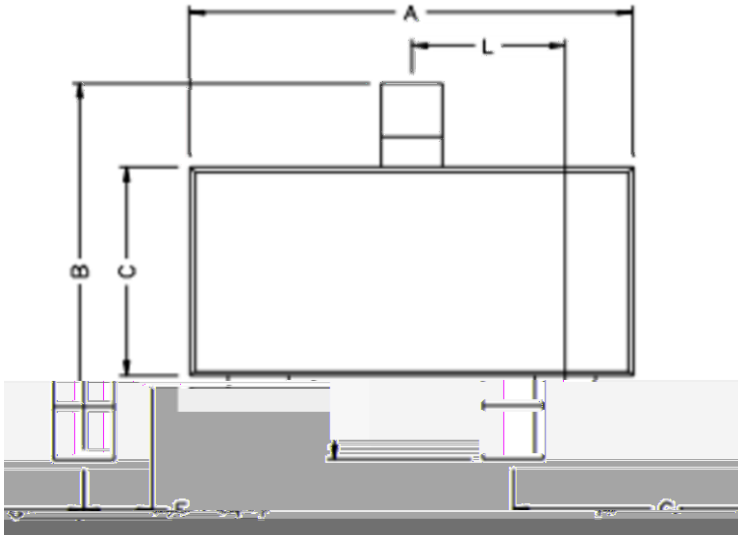


Figure3. Normalized Maximum Transient Thermal Impedance

Mechanical Data

SOT-23 Package Outline(Unit:mm)



REF.	Millimeter		REF.	Millimete	
	Min.	Máx.		Min.	Máx.
A	2.80	3.00	G	1.80	2.00
B	2.30	2.50	H	0.90	1.1
C	1.20	1.40	K	0.10	0.20
D	0.30	0.50	J	0.35	0.70
E	0	0.10	L	0.92	0.98
F	0.45	0.55	M	0°	10°

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